

REACTIVE CODOPING OF GaAlInP COMPOUND SEMICONDUCTORS

Contractual Origin of the Invention

The United States Government has rights in this invention under Contract No. DE-AC36-99GO10337 between the United States Department of Energy and the National Renewal Energy Laboratory, a division of the Midwest Research Institute.

Technical Field

This invention relates generally to a GaAlInP compound semiconductor and the production of GaAlInP compound semiconductors and, more particularly, it relates to reactive codoping of GaAlInP compound semiconductors for improved electrical conductivity and dopant stability in heavily doped layers.

Background Art

Semiconductor devices, such as solar cells and LEDs, require regions with differing types (n-type or p-type) and levels of conductivity. Adding impurity atoms, known as dopants, either to add or remove free electrons, varies the conductivity of the semiconductor device. For some semiconductor materials, it is difficult to obtain high p-type conductivity because of the solubility, activation, and diffusion dynamics of the materials in question. Heavy p-type doping of GaAlInP compound semiconductors with high Al content, such as AlInP, is difficult to achieve with single acceptor species such as Zn, Mg, or Be. Therefore, a method for production of GaAlInP compound semiconductors is needed which greatly enhances the incorporation and solubility of acceptor impurities in GaAlInP grown lattice matched to GaAs substrates which is useful with conventional techniques such as metal organic chemical vapor deposition (MOCVD) or molecular beam epitaxy (MBE). It is also desirable that the method produces low resistivity p-type material with the important benefit of reduced atomic diffusion of the acceptor dopants.

Disclosure of Invention

The present invention is a method of producing a GaAlInP compound semiconductor. The method comprising the steps of disposing a GaAs single crystal as a substrate in a metal organic chemical vapor deposition (MOCVD) reactor, preparing Al, Ga, In vapors by thermally decomposing organometallic compounds of Al, Ga, and In, preparing Zn vapors by thermally decomposing an organometallic Zn compound, preparing P vapors by thermally decomposing phosphine gas, simultaneously supplying the Al, Ga, In, P, Se, and Zn vapors to a region for

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epitaxial crystal growth on the substrate, and epitaxially growing a GaAlInP crystal doped with Zn and Se on the substrate wherein the Zn and Se vapors supplied to the region for epitaxial crystal growth produce a codoped GaAlInP compound semiconductor with Zn serving as a p-type dopant at an atomic ratio of Zn:Se greater than two (2) in the GaAlInP crystal.

5 The present invention additionally further includes a method of producing a GaAlInP compound semiconductor. The method comprises the steps of disposing a GaAs single crystal as a substrate in a metal organic vapor deposition reactor, preparing Al, Ga, In vapors by thermally decomposing organometallic compounds of Al, Ga, and In, preparing P vapors by thermally decomposing phosphine gas, preparing group II element vapors by thermally decomposing an
10 organometallic group IIA or IIB compound, preparing group VIB vapors by thermally decomposing a gaseous compound of group VIB, simultaneously supplying the Al, Ga, In, P, group II, and group VIB vapors to a region for epitaxial crystal growth on the substrate, and epitaxially growing a GaAlInP crystal doped with group IIA or IIB and group VIB elements on said substrate wherein the group IIA or IIB and group VIB vapors supplied to the region for epitaxial crystal growth produce
15 a codoped GaAlInP compound semiconductor with a group IIA or IIB element serving as a p-type dopant having low group II atomic diffusion at an atomic ratio of II:VI greater than approximately two (2) in the GaAlInP crystal.

 The present invention further includes a GaAlInP compound semiconductor. The GaAlInP compound semiconductor comprises a substrate with the substrate being a GaAs single crystal
20 positioned within a metal organic chemical vapor deposition (MOCVD) reactor. Al, Ga, In vapors are thermally decomposed from organometallic compounds of Al, Ga, and In. P vapors are thermally decomposed phosphine gas. Group II element vapors are thermally decomposed from an organometallic group IIA or IIB compound. Group VIB vapors are thermally decomposed from a gaseous compound of group VIB with the Al, Ga, In, P, group II, and group VIB vapors being
25 applied to a region for epitaxial crystal growth on the substrate wherein the group IIA or IIB and group VIB produce a codoped GaAlInP compound semiconductor with a group IIA or IIB element serving as a p-type dopant having low group II atomic diffusion at an atomic ratio of II:VI greater than approximately two (2) in the GaAlInP crystal.

Brief Description of Drawings

The accompanying drawings, which are incorporated in and form a part of the specification, illustrate the preferred embodiments of the present invention, and together with the descriptions serve to explain the principles of the invention.

In the Drawings:

Figure 1 is a schematic view of a metal organic chemical vapor deposition (MOVCD) reactor, constructed in accordance with the present invention;

Figure 2 is a graph of a secondary ion mass spectroscopy (SIMS) profile of the atomic Zn concentration in an AlInP crystal doped with Zn only and the measured electrical properties;

10 Figure 3 is a graph of a secondary ion mass spectroscopy (SIMS) profile of the atomic Zn and Se concentrations in an AlInP crystal codoped with Zn and Se and the measured electrical properties illustrating that low resistivity p-type AlInP was obtained;

15 Figure 4 is a graph of a secondary ion mass spectroscopy (SIMS) profile of the atomic Zn concentration in a highly Zn-doped AlInP crystal doped with Zn only illustrating significant Zn diffusion from AlInP layer into the GaAs substrate; and

Figure 5 is a graph of a secondary ion mass spectroscopy (SIMS) profile of the atomic Zn concentration in a highly Zn-doped AlInP crystal codoped with Zn and Se illustrating greatly reduced Zn diffusion compared to Figure 4.

Best Mode for Carrying Out the Invention

20 The present invention is a method utilizing two (2) doping atoms, an n-type (Se) and a p-type (Zn), to increase the p-type conductivity thereby greatly enhancing the incorporation of Zn acceptor impurities in AlInP lattice-matched to GaAs compound substrates. The method of the present invention uses the simultaneous doping with both donor (Se) and acceptor (Zn) impurities to enhance the solubility of Zn and the doping level in p-type AlInP. By increasing the n-type donor
25 to a sufficient level, the incorporation of the p-type acceptor will increase significantly thereby lowering the resistivity and increasing the conductivity of the AlInP crystal.

As illustrated in Figure 1, the AlInP epitaxial layers were grown on GaAs substrates by low-pressure metal organic chemical vapor deposition (MOCVD). It should be noted that while the present invention describes using low pressure metal organic chemical vapor deposition (MOCVD),
30 other techniques of growing the AlInP epitaxial layers are within the scope of the present invention.

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As illustrated in Figure 1, the low pressure metal organic chemical vapor deposition (MOVCD), indicated generally at 10, feeds purified H_2 and N_2 carrier gas 12 into a computer controlled gas switching manifold 14. The carrier gas 12 flows through the gas switching manifold 14 wherein the carrier gas 12 is saturated with hydride gaseous sources 16 (AsH_3 , PH_3 , H_2Se , and Si_2H_6 , for example) and organometallic liquid sources 18 (trimethylaluminum (TMAI), triethylgallium (TEGa), trimethylindium (TMIn), and dimethylzinc (DMZn), for example). The saturated gas 20 is then transported into a quartz reactor 22, where the saturated gas 20 impinges on a single substrate crystal 24 of GaAs resting on a heated SiC susceptor 26. Preferably, the quartz reactor 22 has a hydrogen/arsine gas ambient with the GaAs substrate crystal 24 heated to a temperature of approximately $640^\circ C$ by radio frequency induction or other means.

By controlling the amounts of Ga, Al, In, the composition of the layer deposited on the GaAs substrate crystal 24 can be determined. In the present embodiment, a 0.1 micron thick GaAs layer is deposited on the GaAs substrate crystal 24 at approximately $640^\circ C$ by introducing triethylgallium into the reactor for a controlled amount of time, i.e., approximately ten (10) minutes to produce an atomically flat surface with monolayer high steps and terraces. The GaAs substrate and epilayer are cooled to approximately $600^\circ C$ in the hydrogen/arsine gas ambient.

The gases phosphine, trimethylindium, trimethylaluminum, dimethylzinc, and hydrogen selenide are then transported into the quartz reactor 22 to deposit a p-type layer of AlInP codoped with zinc and selenium impurities. The incorporation of zinc is increased by a factor of approximately four (4) to approximately ten (10) over a layer with zinc doping only. This leads to a highly conductive p-type crystal with a stable Zn-dopant profile, i.e., Zn atomic diffusion in the Zn and Se codoped layer is greatly reduced compared to the a Zn-doped layer only.

A vacuum pump 28 can be connected to the quartz reactor 22 to reduce the pressure within the quartz reactor 22 and a hydride scrubber 30 can be connected to the quartz reactor 22 to remove any residual gases which are not decomposed.

The AlInP epitaxial layers were simultaneously doped with Zn from DMZn and Se (from H_2Se). Up to a six-fold increase in the atomic Zn concentrations up to $8 \times 10^{20} \text{ cm}^{-3}$ were obtained. Reduced Zn outdiffusion from codoped layers with high Zn concentrations were also obtained. Codoped AlInP with high hole concentrations of up to $6 \times 10^{17} \text{ cm}^{-3}$ with corresponding low resistivities of 0.26 ohm-cm were obtained. This codoping method of the present invention can also use other donor-acceptor pairs such as Mg or Be acceptors atoms and S or Te donor atoms.

Examples

The following examples illustrate the group II acceptor doping enhancement by codoping AlInP with a group IIA acceptor and a group VIB donor. In these examples, Zn is used as the group II acceptor and Se is used as the group VI donor although other group II acceptors and other group VI donors are within the scope of the present invention.

Example 1

A GaAs single crystal with a 511A crystallographic orientation was used as a substrate for the growth of an AlInP single crystal and was located in a metal organic chemical vapor deposition (MOCVD) reactor held at seventy-five (75) torr. AlInP single crystals closely lattice matched to the GaAs were epitaxially grown at temperatures of 540°C – 600°C by supplying 0.4 sccm of trimethylaluminum, 0.22 sccm of trimethylindium, and 250 sccm of phosphine in ten (10) slm of hydrogen carrier gas. Zn doping was accomplished by introducing dimethylzinc at flow rates of 0.32 to 3.2 sccm. Se doping was accomplished by introducing a gas mixture consisting of 100 ppm of H₂Se in hydrogen at flow rates of two (2) to one hundred (100) sccm. Various combinations of Zn doped only and Zn + Se codoped AlInP crystals were grown. The atomic Zn and Se concentrations, N_{Zn} and N_{Se}, respectively, were measured by secondary ion mass spectroscopy (SIMS) and are summarized in Table 1. In the AlInP crystal grown at 600°C, the Zn doping level was increased from 4.5 x 10¹⁸ cm⁻³ in the zinc doped only crystals (samples 1 – 3) to 1.1 – 3.0 x 10¹⁹ cm⁻³ in Zn + Se codoped crystals (samples 4 – 6). In the AlInP crystal grown at 540°C, the Zn doping level was increased from 2 x 10²⁰ cm⁻³ in the zinc doped only crystals (sample 7) to 8 x 10²⁰ cm⁻³ in the Zn + Se codoped crystals (sample 8).

Sample	Temperature (°C)	DMZn flowrate (sccm)	H ₂ Se flowrate (sccm)	N _{Se} (cm ⁻³)	N _{Zn} (cm ⁻³)
1	600	0.32	0	0	4.5x10 ¹⁸
2	600	1.6	0	0	4.5x10 ¹⁸
3	600	3.2	0	0	4.5x10 ¹⁸
4	600	0.32	2	2.8x10 ¹⁸	1.1x10 ¹⁹
5	600	0.32	5	6.5x10 ¹⁸	1.7x10 ¹⁹
6	600	0.32	10	1.1x10 ¹⁹	3x10 ¹⁹
7	540	0.32	0	0	2x10 ²⁰
8	540	0.32	100	2.5x10 ²⁰	8x10 ²⁰

Example 2

A GaAs single crystal with a 511A crystallographic orientation was used as a substrate for the growth of an AlInP single crystal and was located in a metal organic chemical vapor deposition (MOCVD) reactor at held seventy-five (75) torr. Zn doped only and Zn + Se codoped AlInP single crystals closely lattice matched to the GaAs were epitaxially grown on an undoped AlInP buffer layer at temperature of 600°C by supplying 0.4 sccm of trimethylaluminum, 0.22 sccm of trimethylindium, and 250 sccm of phosphine in ten (10) slm of hydrogen carrier gas. Zn doping was accomplished by introducing dimethylzinc at flow rate of 1.6 sccm. Se doping was accomplished by introducing a gas mixture consisting of 100 ppm of H₂Se in hydrogen at a flow rate of ten (10) sccm. The profiles of atomic Zn and Se concentrations, N_{Zn} and N_{Se}, respectively, in Zn doped only and Zn + Se codoped AlInP single crystals were measured by secondary ion mass spectroscopy (SIMS) and are illustrated in Figures 2 and 3, respectively. The hole concentration, p, the mobility, μ , AND THE HOLE RESISTIVITY, ρ , WERE MEASURED BY THE HALL EFFECT AND ARE ILLUSTRATED IN FIGURES 2 AND 3. IN THE ZINC DOPED ALINP crystal, the Zn doping level was $N_{Zn} = 3.5 \times 10^{18} \text{ cm}^{-3}$, $p = 6.2 \times 10^{17} \text{ cm}^{-3}$, $\mu = 62 \text{ Vs/cm}^2$, and $\rho = 0.16 \text{ }\Omega\text{cm}$. In the Zn + Se codoped AlInP crystal, the Zn doping level increased to $N_{Zn} = 2 \times 10^{19} \text{ cm}^{-3}$, while the hole concentration, mobility, and resistivity were $p = 5 \times 10^{17} \text{ cm}^{-3}$, $\mu = 48 \text{ Vs/cm}^2$, $\rho = 0.26 \text{ }\Omega\text{cm}$. These results demonstrated that low p-type resistivity was obtained in Zn + Se codoped AlInP.

Example 3

A GaAs single crystal with a 511A crystallographic orientation was used as a substrate for the growth of an AlInP single crystal and was located in a metal organic chemical vapor deposition (MOCVD) reactor at held seventy-five (75) torr. Very heavily Zn doped AlInP single crystals closely lattice matched to the GaAs were epitaxially grown at temperature of 540°C by supplying 0.4 sccm of trimethylaluminum, 0.22 sccm of trimethylindium, and 400 sccm of phosphine in ten (10) slm of hydrogen carrier gas. Zn doping was accomplished by introducing dimethylzinc at a flow rate of 0.32 sccm. Se doping was accomplished by introducing a gas mixture consisting of 100 ppm of H₂Se in hydrogen at a flow rate of one hundred (100) sccm. The profiles of atomic Zn and Se concentrations, N_{Zn} and N_{Se}, respectively, in Zn doped only and Zn + Se codoped AlInP single crystals were measured by secondary ion mass spectroscopy (SIMS) and are illustrated in Figure 4 and Figure 5, respectively. At these high Zn concentrations, significant Zn diffusion from the

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AlInP crystal into the GaAs substrate crystal occurs as shown in Figure 4 in the Zn-doped only AlInP crystal. An diffusion is greatly reduced in the codoped AlInP crystal as illustrated in Figure 5, resulting in a very sharp Zn dopant profile even though the Zn concentration is four times larger than the case of Figure 4.

5 The present invention uses reactive codoping to enhance incorporation of Zn acceptor impurities in AlInP lattice-matched to GaAs substrates. The present invention additionally uses the simultaneous doping with both donor (Se) and acceptor (Zn) impurities to enhance the solubility of Zn and the doping level in p-type AlInP. The present invention finds industrial applicability in the use of GaAlInP compound semiconductors for: a high gap top-cell, window layer, tunnel
10 junction, or back-surface field layer of tandem solar cells; red to yellow-green high brightness visible LEDs for energy efficient traffic signals; and visible laser diodes for digital video disc technology. Crystal production uses the molecular beam epitaxy (MBE) process or a metal organic chemical vapor deposition (MOCVD) process.

15 The compound semiconductor alloy GaAlInP of the present invention has widespread technological and commercial applications in optoelectronic devices such as tandem solar cells, high brightness visible LEDs, and in visible laser diodes. The present invention utilizes codoping of AlInP with Zn and Se to enhance Zn incorporation and stabilize Zn diffusion in highly p-type dopes AlInP.

20 The foregoing exemplary descriptions and the illustrative preferred embodiments of the present invention have been explained in the drawings and described in detail, with varying modifications and alternative embodiments being taught. While the invention has been so shown, described and illustrated, it should be understood by those skilled in the art that equivalent changes in form and detail may be made therein without departing from the true spirit and scope of the invention, and that the scope of the present invention is to be limited only to the claims except as
25 precluded by the prior art. Moreover, the invention as disclosed herein, may be suitably practiced in the absence of the specific elements which are disclosed herein.